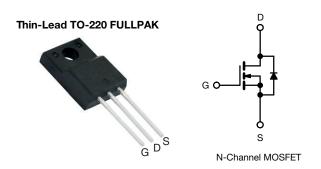
Vishay Siliconix

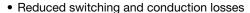
EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	85	50		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.263		
Q _g max. (nC)	6	3		
Q _{gs} (nC)	Ś)		
Q _{gd} (nC)	19			
Configuration	Sin	Single		

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))



Avalanche energy rated (UIS)

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA17N80AEF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise parameter			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	.,
Gate-source voltage			V_{GS}	± 30	V
Continuous drain current (T _J = 150 °C) ^e	V -140V	T _C = 25 °C	- I _D	6.5	А
	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		4.1	
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				0.27	W/°C
Single pulse avalanche energy b			E _{AS}	127	mJ
Maximum power dissipation			P_{D}	34	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		-l / -l.b	100	V/ns	
Reverse diode dv/dt d		dv/dt	50		
Soldering recommendations (peak temperature) c		For 10 s		260	°C
Mounting torque	M3 s	screw	-	0.6	Nm

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 450 A/ μ s, starting T_J = 25 °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R_{thJA}	1	65	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	3.7	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-source breakdown voltage	V _{DS}	V _{GS} =	800	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2	-	4	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μΑ
		V _{DS} =	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.5 A	-	0.263	0.305	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 8.5 A		-	8.6	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	1300	-	pF
Output capacitance	C _{oss}			-	48	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related	$C_{o(er)}$	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	39	-	
Effective output capacitance, time related	C _{o(tr)}			-	240	-	
Total gate charge	Qg			-	42	63	
Gate-source charge	Q_{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 8.5 \text{ A}, V_{DS} = 640 \text{ V}$		9	-	nC
Gate-drain charge	Q _{gd}				19	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 640 \text{ V}, I_{D} = 8.5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	16	32	
Rise time	t _r			-	20	40	
Turn-off delay time	t _{d(off)}			-	32	64	ns
Fall time	t _f			-	38	76	
Gate input resistance	R_g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.5	
Pulsed diode forward current	I _{SM}			-	-	32	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 8.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	114	228	ns
Reverse recovery charge	Q _{rr}	$T_J = 25$ °C, $I_F = I_S = 8.5$ A, di/dt = 100 A/ μ s, $V_R = 400$ V		-	0.7	1.4	μC
Reverse recovery current	I _{RRM}			-	12	-	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

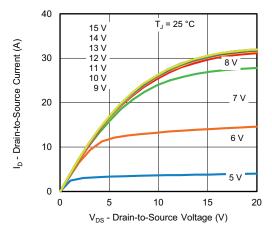


Fig. 1 - Typical Output Characteristics

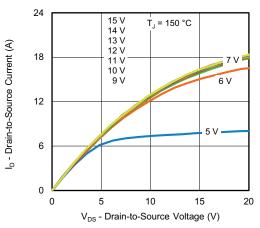


Fig. 2 - Typical Output Characteristics

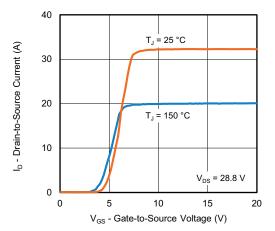


Fig. 3 - Typical Transfer Characteristics

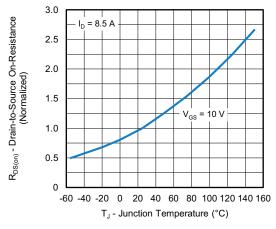


Fig. 4 - Normalized On-Resistance vs. Temperature

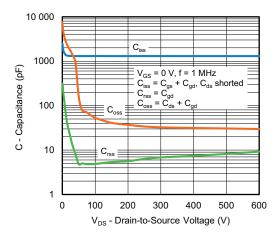


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

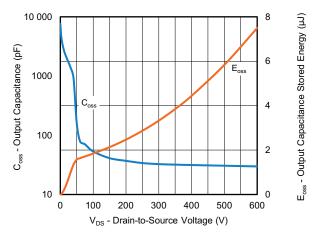


Fig. 6 - Coss and Eoss vs. VDS



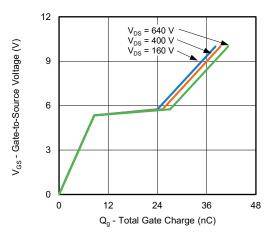


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

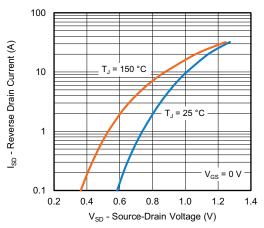


Fig. 8 - Typical Source-Drain Diode Forward Voltage

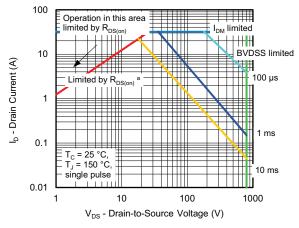


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

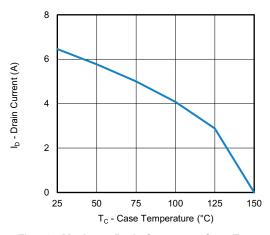


Fig. 10 - Maximum Drain Current vs. Case Temperature

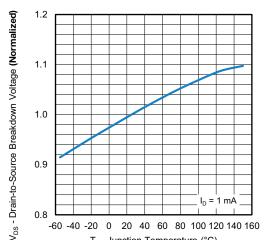


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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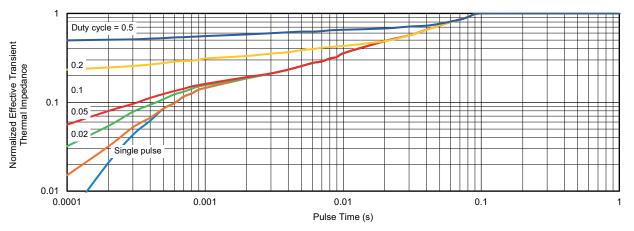


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

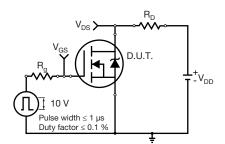


Fig. 13 - Switching Time Test Circuit

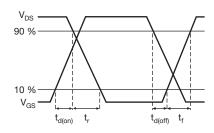


Fig. 14 - Switching Time Waveforms

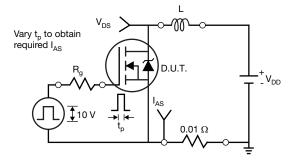


Fig. 15 - Unclamped Inductive Test Circuit

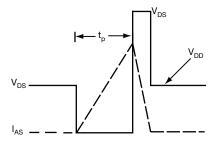


Fig. 16 - Unclamped Inductive Waveforms

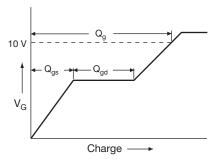


Fig. 17 - Basic Gate Charge Waveform

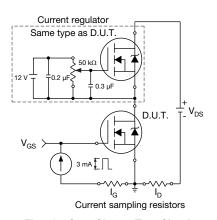


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit

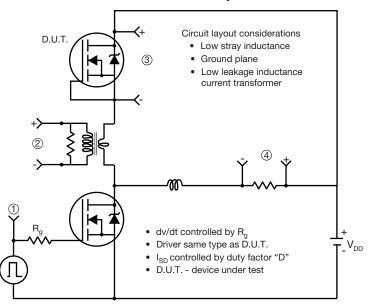




Fig. 19 - For N-Channel

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